

AMENDMENTS

In the Claims

The following is a marked-up version of the claims with the language that is underlined (“___”) being added and the language that contains strikethrough (“—”) being deleted:

1. – 8. (Canceled)

9. (Currently Amended) A data storage device comprising:

a first wafer having a storage medium, said storage medium having data clusters, each of said data clusters having storage areas associated therewith, each of said storage areas being configurable in one of a plurality of structural states to represent information stored in said storage area;

a second wafer fixed in position relative to said first wafer, said second wafer having electron beam emitters configured to electrically communicate with said storage medium, said storage medium and said electron beam emitters being configured to move relative to each other such that at least one of said electron beam emitters is capable of providing a beam of electrons to storage areas of a first data cluster for configuring each of said storage areas in one of said structural states; and

means for preventing said at least one of said electron beam emitters from attempting to write data to one of said data clusters other than said first data cluster such that said first data cluster is spaced from others of said data clusters.

10. (Original) The data storage device of claim 9, wherein said means for preventing comprises:

means for preventing said at least one of said electron beam emitters from aligning with one of said data clusters other than said first data cluster.

11. (Original) The data storage device of claim 9, wherein said means for preventing comprises:

means for accommodating a manufacturing tolerance associated with fixing the position of said first wafer and said second wafer.

12. (Original) The data storage system of claim 9, wherein said means for preventing comprises:

means for enabling signals associated with a storage area to be propagated through an area provided between adjacent ones of said data clusters.

13. (Original) The data storage device of claim 9, further comprising:
means for propagating signals from said storage areas.

14. (Currently Amended) A method for storing data, said method comprising:
providing a data storage device having a first wafer and a second wafer, the first wafer having a storage medium, the storage medium having storage areas associated therewith, each of the storage areas being configurable in one of a plurality of structural states to represent information stored in the storage area, the second wafer being fixed in position relative to the first wafer, the second wafer having electron beam emitters configured to electrically communicate with the storage medium, the storage medium and the electron beam emitters

being configured to move relative to each other such that at least one of the electron beam emitters is capable of providing a beam of electrons to a first storage area for configuring the first storage area in one of the structural states and to a second storage area for configuring the second storage area in one of the structural states; and

preventing the at least one of the electron beam emitters from writing data to a ~~second~~ third storage area, the first storage area and the ~~second~~ third storage area having a separation area located therebetween, the separation area being larger than a space located between the first storage area and the second storage area.

15. (Canceled)

16. (Previously Presented) The method of claim 14, wherein preventing comprises:

accommodating a manufacturing tolerance associated with fixing the position of the first wafer and the second wafer.

17. (Previously Presented) The method of claim 14, wherein preventing comprises:

providing a contact area between the first storage area and at least one adjacent storage area; and

enabling signals associated with the first storage area to be propagated through the contact area.

18. (Previously Presented) The method of claim 14, wherein:
the first storage area has a contact associated therewith, the contact being configured to enable reading of data from the first storage area; and
further comprising:
preventing the at least one of the electron beam emitters associated with the first storage area from attempting to write data to a location associated with the contact.

19. (Canceled)

20. (Previously Presented) The method of claim 17, further comprising:
calibrating the at least one of the emitters such that the at least one of the emitters does not attempt to write data within the contact area.

21. (Previously Presented) A data storage device comprising:
a first wafer having a storage medium, said storage medium having data clusters, each of said data clusters having storage areas associated therewith, said storage areas being configurable in a plurality of structural states to represent information;
a second wafer fixed in position relative to said first wafer, said second wafer having electron beam emitters configured to electrically communicate with said storage medium, said storage medium and said electron beam emitters being configured to move relative to each other such that at least one of said electron beam emitters is capable of providing a beam of electrons to storage areas of a first data cluster for configuring said storage areas of said first data cluster in said structural states; and
a first cluster separation area defined about said first data cluster and forming a separation between said first data cluster and adjacent ones of said data clusters such that said

at least one of said electron beam emitters is prevented from writing data to one of said data clusters other than said first data cluster.

22. (Previously Presented) The data storage device of claim 21, wherein said first cluster separation area has a width associated with a manufacturing tolerance, said manufacturing tolerance being associated with fixing the position of said first wafer and said second wafer.

23. (Previously Presented) The data storage device of claim 21, wherein said first cluster separation area includes a first guard area, said first guard area being formed on a writable portion of said storage medium such that said at least one of said electron beam emitters associated with said first data cluster can write data to at least a portion of said first guard area.

24. (Previously Presented) The data storage device of claim 21, further comprising:

leads electrically communicating with said data clusters, and wherein said first cluster separation area includes a contact area, said contact area being configured to accommodate placement of said leads therein such that said leads are arranged between adjacent ones of said data clusters.

25. (Previously Presented) The data storage device of claim 22, wherein, when said first wafer and said second wafer are fixed in a position corresponding to said tolerance limit of said manufacturing tolerance, said at least one of said electron beam emitters is aligned with said first cluster separation area.

26. (Previously Presented) The data storage device of claim 24, further comprising:

contacts electrically communicating with said data clusters, said contacts being arranged in groups of contacts, each of said groups being associated with a particular one of said data clusters, each of said groups electrically communicating with one of said leads such that said contacts facilitate electrical communication between said leads and said storage areas of said data clusters.

27. (Previously Presented) The data storage device of claim 25, wherein said tolerance limit is $\pm 5 \mu\text{m}$, and wherein said first guard area has a width of approximately $5 \mu\text{m}$.

28. (Previously Presented) The data storage device of claim 26, further comprising:

a control system electrically communicating with said at least one of said electron beam emitters, said control system being configured to calibrate said at least one of said electron beam emitters such that said at least one of said electron beam emitters is configured not to attempt to write data on a portion of said storage medium occupied by at least one of said contacts.

29. (Previously Presented) The data storage device of claim 21, wherein the electron beam emitters are configured such that only one of the electron beam emitters associated with each of the data clusters is "on" at a time.

30. (Previously Presented) A computer system comprising:

- a processor; and
- a data storage device communicating with the processor, said data storage device comprising:
 - a first wafer having a storage medium, said storage medium having data clusters, each of said data clusters having storage areas associated therewith, said storage areas being configurable a plurality of structural states to represent information stored in said storage area;
 - a second wafer fixed in position relative to said first wafer, said second wafer having electron beam emitters configured to electrically communicate with said storage medium, said storage medium and said electron beam emitters being configured to move relative to each other such that at least one of said electron beam emitters is capable of providing a beam of electrons to storage areas of a first data cluster for configuring said storage areas in said structural states; and
 - a first cluster separation area defined about said first data cluster and forming a separation between said first data cluster and adjacent ones of said data clusters such that said at least one of said electron beam emitters is prevented from writing data to one of said data clusters other than said first data cluster.

31. (Previously Presented) The computer system of claim 30, wherein the processor is operative to execute instructions stored in said storage areas of said data storage device.

32. (Previously Presented) The computer system of claim 30, wherein said first cluster separation area has a width associated with a manufacturing tolerance, said

manufacturing tolerance being associated with fixing the position of said first wafer and said second wafer.

33. (Previously Presented) The computer system of claim 30, wherein said first cluster separation area includes a first guard area, said first guard area being formed on a writable portion of said storage medium such that said at least one of said electron beam emitters associated with said first data cluster can write data to at least a portion of said first guard area.

34. (Previously Presented) The computer system of claim 30, wherein leads electrically communicating with said data clusters, and wherein said first cluster separation area includes a contact area, said contact area being configured to accommodate placement of said leads therein such that said leads are arranged between adjacent ones of said data clusters.

35. (Previously Presented) The computer system of claim 32, wherein, when said first wafer and said second wafer are fixed in a position corresponding to said tolerance limit of said manufacturing tolerance, said at least one of said electron beam emitters is aligned with said first cluster separation area.

36. (Previously Presented) The computer system of claim 34, wherein contacts electrically communicating with said data clusters, said contacts being arranged in groups of contacts, each of said groups being associated with a particular one of said data clusters, each of said groups electrically communicating with one of said leads such that said contacts

facilitate electrical communication between said leads and said storage areas of said data clusters.

37. (Previously Presented) The computer system of claim 35, wherein said tolerance limit is $\pm 5 \mu\text{m}$, and wherein said first guard area has a width of approximately $5 \mu\text{m}$.

38. (Previously Presented) The computer system of claim 30 further comprising:
a control system electrically communicating with said at least one of said electron beam emitters, said control system being configured to calibrate said at least one of said electron beam emitters such that said at least one of said electron beam emitters is configured not to attempt to write data on a portion of said storage medium occupied by at least one of said contacts.

39. (Previously Presented) The computer system of claim 30, wherein the electron beam emitters are configured such that only one of the electron beam emitters associated with each of the data clusters is "on" at a time.